

Doc. Number:

- □ Tentative Specification
- □ Preliminary Specification
- Approval Specification

MODEL NO.: N133HCE SUFFIX: G52

Customer: Common Model				
APPROVED BY	SIGNATURE			
Name / Title Note				
Please return 1 copy for your or signature and comments.	confirmation with your			

Approved By	Checked By	Prepared By

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REVISION HISTORY

Version	Date	Page	Description
3.0	2018/1/18	All	Approval Spec Ver. 3.0 was first issued



1. GENERAL DESCRIPTION

1.1 OVERVIEW

N133HCE-G52 is a 13.3" (13.3" diagonal) TFT Liquid Crystal Display NB module with LED Backlight unit and 30 pins EDP interface. This module supports 1920 x 1080 FHD mode and can display 262,144 colors \circ

1.2 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Screen Size	13.3 diagonal		
Driver Element	a-si TFT active matrix	-	-
Pixel Number	1920 x R.G.B. x 1080	pixel	-
Pixel Pitch	0.1529 (H) x 0.1529 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	262,144	color	-
Interface	eDP 1.3	-	-
Surface Treatment	Hard coating (3H), Anti-Glare	-	-
Luminance, White	300	Cd/m2	
Color Gamma	72%	NTSC	
Power Consumption	Total 3.63 W(Max.) @ cell 0.83W(Max.), BL 2.8 W(M	Лах.)	(1)

Note (1) The specified power consumption (with converter efficiency) is under the conditions at VCCS = 3.3 V, fv = 60 Hz, LED_VCCS = Typ, fPWM = 200 Hz, Duty=100% and Ta = 25 ± 2 °C, whereas BLACK pattern is displayed.

2. MECHANICAL SPECIFICATIONS

Item		Min.	Тур.	Max.	Unit	Note	
	Horizontal (H)	299.96	300.26	300.56	mm		
Module Size	Vertical (V) (w/o FPC)	177.25	177.55	177.85	mm		
	Vertical (V) (with FPC)	177.05	177.55	178.05	mm	(1)(2)	
	Thickness (T) (w/o PCB)	2.1	2.25	2.4	mm		
	Thickness (T) (with PCB)			4.4	mm		
Λ αξίνο Λ ν α α	Horizontal	293.66	293.76	293.86	mm		
Active Area	Vertical	165.14	165.24	165.34	mm		
Weight		-	-	225	g		

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

(2) Dimensions are measured by caliper.





2.1 CONNECTOR TYPE

Please refer Appendix Outline Drawing for detail design.

Connector Part No.: IPEX-20455-030E-76

User's connector Part No: IPEX-20453-030T-03

3. ABSOLUTE MAXIMUM RATINGS

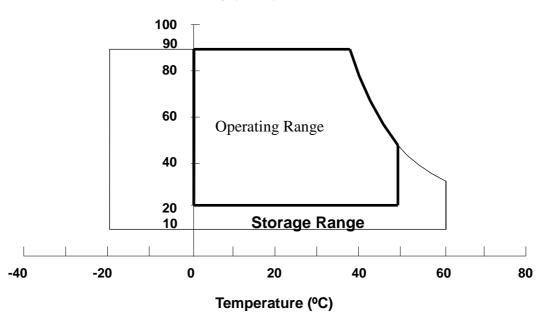
3.1 ABSOLUTE RATINGS OF ENVIRONMENT

Item	Symbol	Value		Unit	Noto	
item	Symbol	Min.	Max.	Offic	Note	
Storage Temperature	T _{ST}	-20	+60	°C	(1)	
Operating Ambient Temperature	T _{OP}	0	+50	°C	(1), (2)	

- Note (1) (a) 90 %RH Max. (Ta < 40 °C).
 - (b) Wet-bulb temperature should be 39 °C Max.
 - (c) No condensation.

Note (2) The temperature of panel surface should be 0 °C min. and 60 °C max.





3.2 ELECTRICAL ABSOLUTE RATINGS

3.2.1 TFT LCD MODULE

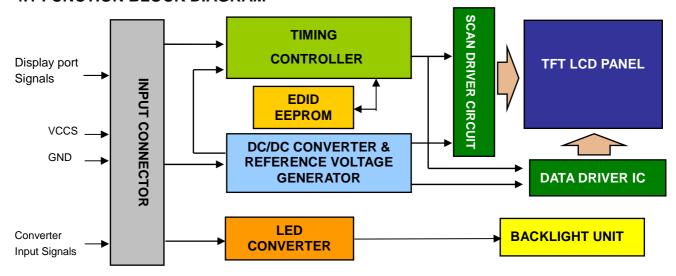
Item	Symbol	Value		Unit	Note
item	Gymbol	Min.	Max.	Offic	Note
Power Supply Voltage	VCCS	-0.3	+4.0	٧	(1)
Logic Input Voltage	V _{IN}	-0.3	VCCS+0.3	V	(1)

Converter Input Voltage	LED_VCCS	-0.3	26	V	(1)
Converter Control Signal Voltage	LED_PWM,	-0.3	5	V	(1)
Converter Control Signal Voltage	LED_EN	-0.3	5	V	(1)

Note (1) Stresses beyond those listed in above "ELECTRICAL ABSOLUTE RATINGS" may cause permanent damage to the device. Normal operation should be restricted to the conditions described in "ELECTRICAL CHARACTERISTICS".

4. ELECTRICAL SPECIFICATIONS

4.1 FUNCTION BLOCK DIAGRAM



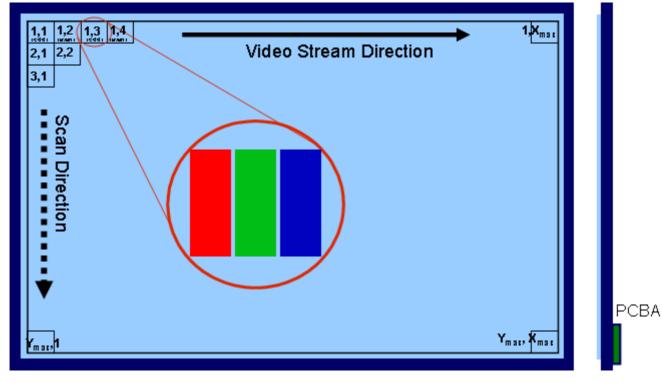
4.2. INTERFACE CONNECTIONS

PIN ASSIGNMENT

Pin	Symbol	Description	Remark
1	CABC_EN	CABC Enable Input	
2	H_GND	High Speed Ground	
3	Lane1_N	Complement Signal Link Lane 1	
4	Lane1_P	True Signal Link Lane 1	
5	H_GND	High Speed Ground	
6	Lane0_N	Complement Signal Link Lane 0	
7	Lane0_P	True Signal Link Lane 0	
8	H_GND	High Speed Ground	
9	AUX_CH_P	True Signal Auxiliary Channel	
10	AUX_CH_N	Complement Signal Auxiliary Channel	
11	H_GND	High Speed Ground	
12	VCCS	LCD logic and driver power	
13	VCCS	LCD logic and driver power	
14	BIST_EN	Panel Built In Self Test Enable	
15	GND	LCD logic and driver ground	
16	GND	LCD logic and driver ground	
17	HPD	HPD signal pin	
18	BL_GND	Backlight ground	

19	BL_GND	Backlight ground
20	BL_GND	Backlight ground
21	BL_GND	Backlight ground
22	LED_EN	Backlight on /off
23	LED_PWM	System PWM signal input for dimming
24	NC	No Connection (Reserved for LCD test)
25	NC	No Connection (Reserved for LCD test)
26	LED_VCCS	Backlight power
27	LED_VCCS	Backlight power
28	LED_VCCS	Backlight power
29	LED_VCCS	Backlight power
30	NC	No Connection (Reserved for LCD test)

Note (1) The first pixel is odd as shown in the following figure.



Note (2) The setting of CABC function are as follows.

Pin	Enable	Disable
CABC_EN	Hi	Lo or Open
BIST_EN	Hi	Lo or Open

Hi = High level, Lo = Low level.



4.3 ELECTRICAL CHARACTERISTICS

4.3.1 LCD ELETRONICS SPECIFICATION

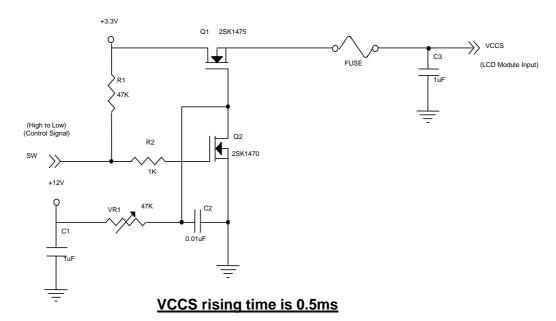
Doromotor		Cumbal		Value		Linit	Note
Parameter		Symbol	Min.	Тур.	Max.	Unit	Note
Power Supply Voltage		VCCS	3.0	3.3	3.6	V	(1)(7)
High Level			2.25	-	2.75	V	(6)
HPD	Low Level		0	-	0.4	V	(6)
HPD Impedance		R _{HPD}	30K			ohm	(5)
Ripple Voltage		V_{RP}	-	-	100	mV	(1)
CE EN Input Voltage	High Level	V_{IHCE}	2.3	-	3.6	V	(5)
CE_EN Input Voltage	Low Level	V_{ILCE}	0	-	0.5	V	(5)
CE_EN Impedance		R _{CE_EN}	30K	-	-	ohm	(5)
CARC EN Input Voltage	High Level	V _{IHCABC}	2.3	-	3.6	V	(5)
CABC_EN Input Voltage	Low Level	V_{ILCABC}	0	-	0.5	V	(5)
CABC_EN Impedance		R _{CABC_EN}	30K	-	-	ohm	(5)
Inrush Current		I _{RUSH}	-	-	1.5	Α	(1),(2)
Mosaic		loo		238	266	mA	(3)a
Power Supply Current	Black	lcc		227	250	mA	(3)
Power per EBL WG	P _{EBL}		1.38	-	W	(4)	

Note (1) The ambient temperature is $Ta = 25 \pm 2$ °C.

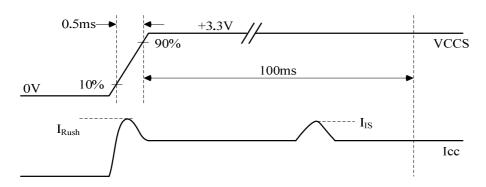
Note (2) I_{RUSH}: the maximum current when VCCS is rising

I_{IS}: the maximum current of the first 100ms after power-on

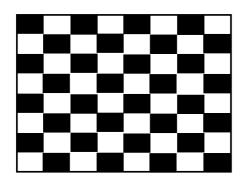
Measurement Conditions: Shown as the following figure. Test pattern: black.





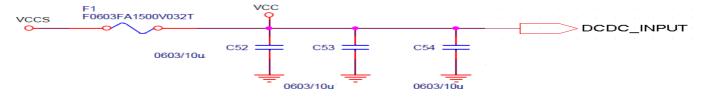


- Note (3) The specified power supply current is under the conditions at VCCS = 3.3 V, Ta = 25 ± 2 °C, DC Current and $f_v = 60$ Hz, whereas a power dissipation check pattern below is displayed.
 - a. Mosaic Pattern



Active Area

- Note (4) The specified power are the sum of LCD panel electronics input power and the converter input power. Test conditions are as follows.
 - (a) VCCS = 3.3 V, Ta = $25 \pm 2 \, ^{\circ}\text{C}$, $f_v = 60 \text{ Hz}$,
 - (b) The pattern used is a black and white 32 x 36 checkerboard, slide #100 from the VESA file "Flat Panel Display Monitor Setup Patterns", FPDMSU.ppt.
 - (c) Luminance: 60 nits
- Note (5) The specified signals have equivalent impedances pull down to ground in the LCD module respectively. Customers should keep the input signal level requirement with the load of LCD module. Please refer to Note (4) of 4.3.2 LED CONVERTER SPECIFICATION to obtain more information.
- Note (6) When a source detects a low-going HPD pulse, it must be regarded as a HPD event. Thus, the source must read the link / sink status field or receiver capability field of the DPCD and take corrective action
- Note (7) Input VCC Circuit is as below



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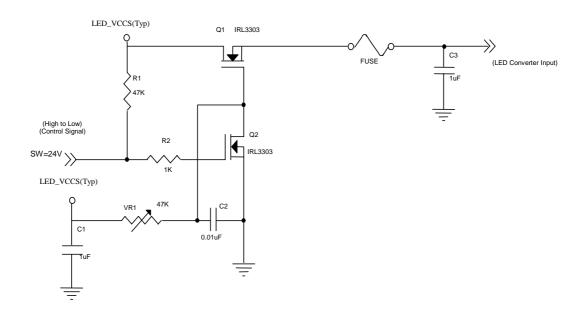
4.3.2 LED CONVERTER SPECIFICATION

Parar	motor	Cumbal		Value		Unit	Note
Parai	netei	Symbol	Min.	Тур.	Max.	Onit	Note
Converter Input pow	LED_Vccs	5	12	21	V		
Converter Inrush Cu	rrent	ILED _{RUSH}	-	-	1.5	А	(1)
EN Control Level	Backlight On		2.2	-	3.6	V	(4)
Backlight Off			0	-	0.6	V	(4)
LED_EN Impedance)	R _{LED_EN}	30K	-	-	ohm	(4)
PWM Control Level	PWM High Level		2.2	-	3.6	V	(4)
PWW Control Level	PWM Low Level		0	-	0.6	V	(4)
PWM Impedance		R_{PWM}	30K	-	-	ohm	(4)
PWM Control Duty F	Ratio		5	-	100	%	(5)
PWM Control Permissive Ripple Voltage		VPWM_pp	-	-	100	mV	
PWM Control Frequ	f_{PWM}	190	-	2K	Hz	(2)	
LED Power Current	LED_VCCS =Typ.		186	220	231	mA	(3)

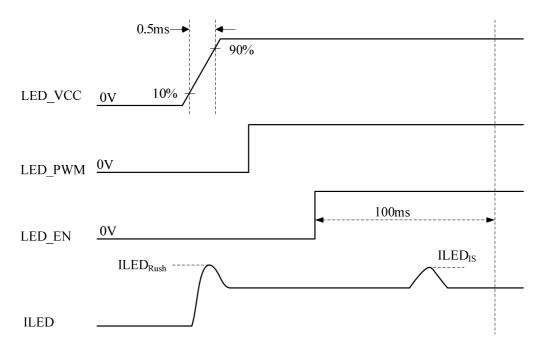
Note (1) ILED_{RUSH}: the maximum current when LED_VCCS is rising,

ILED_{IS}: the maximum current of the first 100ms after power-on,

Measurement Conditions: Shown as the following figure. LED_VCCS = Typ, Ta = 25 ± 2 °C, f_{PWM} = 200 Hz, Duty=100%.



VLED rising time is 0.5ms



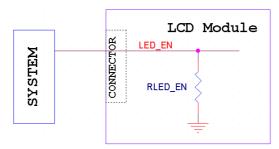
Note (2) If PWM control frequency is applied in the range less than 1KHz, the "waterfall" phenomenon on the screen may be found. To avoid the issue, it's a suggestion that PWM control frequency should follow the criterion as below.

PWM control frequency f_{PWM} should be in the range

$$(N+0.33)*f \le f_{PWM} \le (N+0.66)*f$$

 $N: Integer \ (N \ge 3)$
 $f: Frame rate$

- Note (3) The specified LED power supply current is under the conditions at "LED_VCCS = Typ.", Ta = 25 \pm 2 °C, f_{PWM} = 200 Hz, Duty=100%.
- Note (4) The specified signals have equivalent impedances pull down to ground in the LCD module respectively. Customers should keep the input signal level requirement with the load of LCD module. For example, the figure below describes the equivalent pull down impedance of LED_EN (If it exists). The rest pull down impedances of other signals (eg. HPD, PWM ...) are in the same concept.



Note (5) If the cycle-to-cycle difference of PWM duty exceeds 0.1%, especially when the PWM duty is low, slight brightness change might be observed.

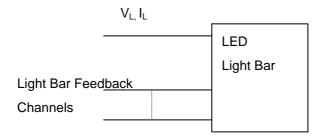


4.3.3 BACKLIGHT UNIT

Ta = 25 ± 2 °C

Doromotor	Cumahal		Value	l lm!s	Nete	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
LED Light Bar Power Supply Voltage	VL	26.0	28.0	30.0	V	(4)(2)(Dut)(4,000()
LED Light Bar Power Supply Current	lL		80		mA	(1)(2)(Duty100%)
Power Consumption	PL	-	2.240	2.40	W	(3)
LED Life Time	L_BL	15000	-	-	Hrs	(4)

Note (1) LED current is measured by utilizing a high frequency current meter as shown below:



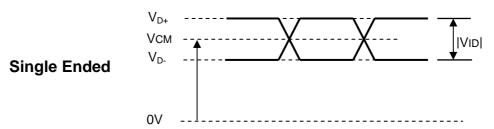
- Note (2) For better LED light bar driving quality, it is recommended to utilize the adaptive boost converter with current balancing function to drive LED light-bar.
- Note (3) $P_L = I_L \times V_L$ (Without LED converter transfer efficiency)
- Note (4) The lifetime of LED is defined as the time when it continues to operate under the conditions at Ta = 25 \pm 2 °C and I_L = 16 mA (Per EA) until the brightness becomes \leq 50% of its original value.

4.4 DISPLAY PORT INPUT SIGNAL TIMING SPECIFICATIONS

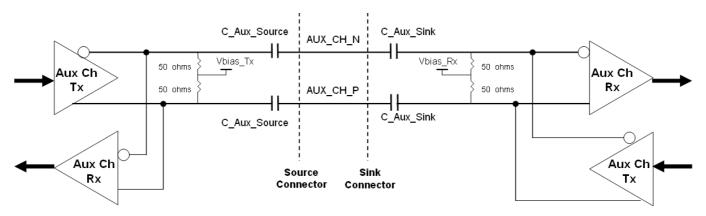
4.4.1 ELECTRICAL SPECIFICATIONS

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Differential Signal Common Mode Voltage(MainLink and AUX)	VCM	0		2	V	(1)(4)
AUX AC Coupling Capacitor	C_Aux_Source	75		200	nF	(2)
Main Link AC Coupling Capacitor	C_ML_Source	75		200	nF	(3)

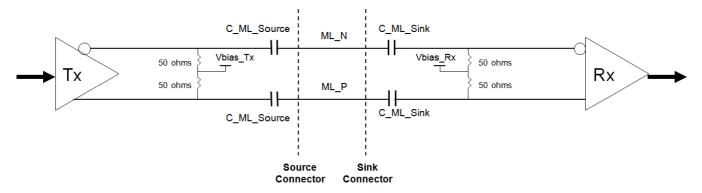
Note (1)Display port interface related AC coupled signals should follow VESA DisplayPort Standard Version1. Revision 1a and VESA Embedded DisplayPort[™] Standard Version 1.2. There are many optional items described in eDP1.3. If some optional item is requested, please contact us.



(2) Recommended eDP AUX Channel topology is as below and the AUX AC Coupling Capacitor (C_Aux_Source) should be placed on the source device.



(3) Recommended Main Link Channel topology is as below and the Main Link AC Coupling Capacitor (C_ML_Source) should be placed on the source device.



(4) The source device should pass the test criteria described in DisplayPortCompliance Test Specification (CTS) 1.1



4.4.2 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input the brighter the color. The table below provides the assignment of color versus data input.

												D	ata	Sig	nal										
	Color				Re	ed							Gre	en							Bl	ue			
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	ВЗ	B2	B1	B0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
Basic	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Red(2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Red	Red(253)	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
Gray	Green(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Green	Green(253)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
	Green(254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	Green(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Blue(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
Gray	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Blue	Blue(253)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
	Blue(254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Blue(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

Note (1) 0: Low Level Voltage, 1: High Level Voltage



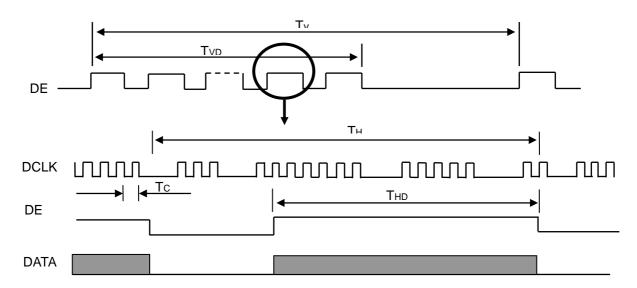
4.5 DISPLAY TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

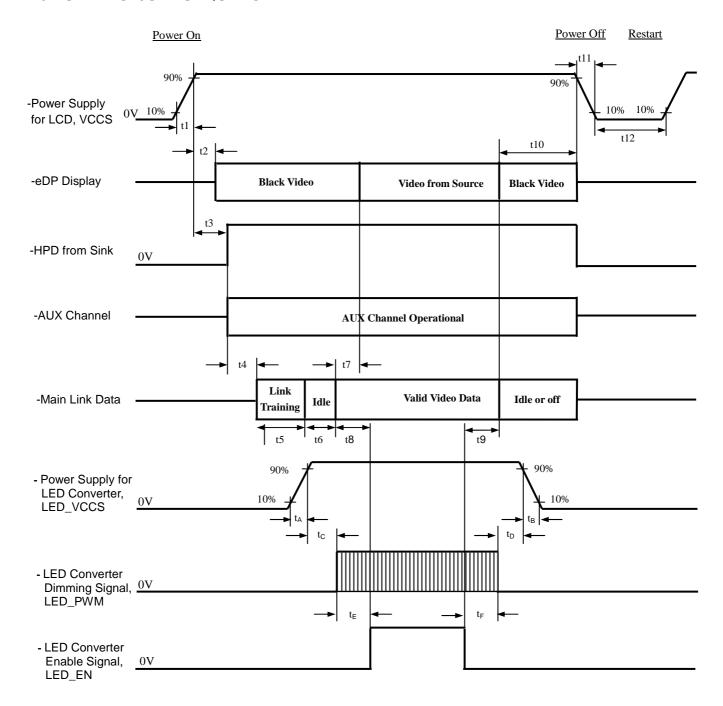
Refresh Rate 60Hz

Signal	Item	Symbol	Min.	Тур.	Max.	Unit	Note
DCLK	Frequency	1/Tc	152.08	152.84	153.6	MHz	-
DE	Vertical Total Time	TV	1128	1132	1136	TH	-
	Vertical Active Display Period	TVD	1080	1080	1080	TH	-
	Vertical Active Blanking Period	TVB	TV-TVD	52	TV-TVD	TH	-
	Horizontal Total Time	TH	2230	2250	2270	Тс	-
	Horizontal Active Display Period	THD	1920	1920	1920	Tc	-
	Horizontal Active Blanking Period	THB	TH-THB	330	TH-THB	Tc	-

INPUT SIGNAL TIMING DIAGRAM



4.6 POWER ON/OFF SEQUENCE





Timing Specifications (TBD)

Parameter	Description	Reqd. By	Va Min	lue Max	Unit	Notes
t1	Power rail rise time, 10% to 90%	Source	0.5	10	ms	-
t2	Delay from LCD,VCCS to black video generation	Sink	0	200	ms	Automatic Black Video generation prevents display noise until valid video data is received from the Source (see Notes:2 and 3 below)
t3	Delay from LCD,VCCS to HPD high	Sink	0	200	ms	Sink AUX Channel must be operational upon HPD high (see Note:4 below)
t4	Delay from HPD high to link training initialization	Source	0	-	ms	Allows for Source to read Link capability and initialize
t5	Link training duration	Source	0	-	ms	Dependant on Source link training protocol
t6	Link idle	Source	0	-	ms	Min Accounts for required BS-Idle pattern. Max allows for Source frame synchronization
t7	Delay from valid video data from Source to video on display	Sink	0	50	ms	Max value allows for Sink to validate video data and timing. At the end of T7, Sink will indicate the detection of valid video data by setting the SINK_STATUS bit to logic 1 (DPCD 00205h, bit 0), and Sink will no longer generate automatic Black Video
t8	Delay from valid video data from Source to backlight on	Source	80	-	ms	Source must assure display video is stable *: Recommended by INX. To avoid garbage image.
t9	Delay from backlight off to end of valid video data	Source	50	-	ms	Source must assure backlight is no longer illuminated. At the end of T9, Sink will indicate the detection of no valid video data by setting the SINK_STATUS bit to logic 0 (DPCD 00205h, bit 0), and Sink will automatically display Black Video. (See Notes: 2 and 3 below) *: Recommended by INX. To avoid garbage image.
t10	Delay from end of valid video data from Source to power off	Source	0	500	ms	Black video will be displayed after receiving idle or off signals from Source
t11	VCCS power rail fall time, 90% to 10%	Source	0.5	10	ms	-



t12	VCCS Power off time	Source	500	-	ms	-
t _A	LED power rail rise time, 10% to 90%	Source	0.5	10	ms	-
t _B	LED power rail fall time, 90% to 10%	Source	0	10	ms	-
t _C	Delay from LED power rising to LED dimming signal	Source	1	-	ms	-
t _D	Delay from LED dimming signal to LED power falling	Source	1	1	ms	-
t _E	Delay from LED dimming signal to LED enable signal	Source	0	ı	ms	-
t _F	Delay from LED enable signal to LED dimming signal	Source	0	-	ms	-

- Note (1) Please don't plug or unplug the interface cable when system is turned on.
- Note (2) The Sink must include the ability to automatically generate Black Video autonomously. The Sink must automatically enable Black Video under the following conditions:
 - Upon LCDVCC power-on (within T2 max)
 - When the "NoVideoStream_Flag" (VB-ID Bit 3) is received from the Source (at the end of T9)
- Note (3) The Sink may implement the ability to disable the automatic Black Video function, as described in Note (2), above, for system development and debugging purposes.
- Note (4) The Sink must support AUX Channel polling by the Source immediately following LCDVCC power-on without causing damage to the Sink device (the Source can re-try if the Sink is not ready).

 The Sink must be able to response to an AUX Channel transaction with the time specified within T3 max.



5. OPTICAL CHARACTERISTICS

5.1 TEST CONDITIONS

Item	Symbol	Value	Unit
Ambient Temperature	Ta	25±2	°C
Ambient Humidity	На	50±10	%RH
Supply Voltage	V_{CC}	3.3	V
Input Signal	According to typical va	alue in "3. ELECTRICAL (CHARACTERISTICS"
LED Light Bar Input Current	Ι _L	80	mA

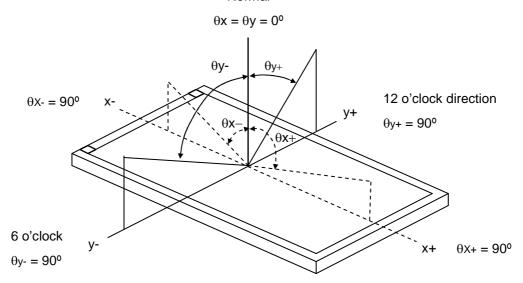
The measurement methods of optical characteristics are shown in Section 5.2. The following items should be measured under the test conditions described in Section 5.1 and stable environment shown in Note (5).

5.2 OPTICAL SPECIFICATIONS

Iter	m	Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Contrast Ratio		CR		600	800	-	-	(2), (5) ,(7)
Response Time	T_R		-	14	19	ms		
Response fille		T_F		-	11	16	ms	(3) ,(7)
Average Lumina	ance of White	Lave		255	300	-	cd/m ²	(4), (6) ,(7)
	Red	Rx	$\theta_x=0^\circ, \ \theta_Y=0^\circ$		0.640		-	
	Keu	Ry	Viewing Normal Angle		0.330		-	
Color Chromaticity	Green	Gx			0.300		-	
		Gy		Тур –	0.600	Typ +	-	(4) (7)
		Bx		0.03	0.150	0.03	-	(1) ,(7)
		Ву			0.060		-	
	White	Wx			0.313		-	
	vvriite	Wy			0.329		-	
	Harizantal	θ_x +		80	85	-		
Viscosia a Assala	Horizontal	θ_{x} -	OD: 40	80	85	-	Dan	(1),(5),
Viewing Angle	\	θ _Y +	CR≥10	80	85	-	Deg.	(7)
Vertical		θ _Y -		80	85	-		
10/leita 1/ania (1)		δW_{5p}	$\theta_x = 0^\circ, \ \theta_Y = 0^\circ$	-	1.11	1.25	-	(5),(6),
White Variation		δW _{13p}	$\theta_x=0^\circ, \ \theta_Y=0^\circ$	-	1.34	1.54	-	(7)



Note (1) Definition of Viewing Angle (θx , θy): Normal



Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

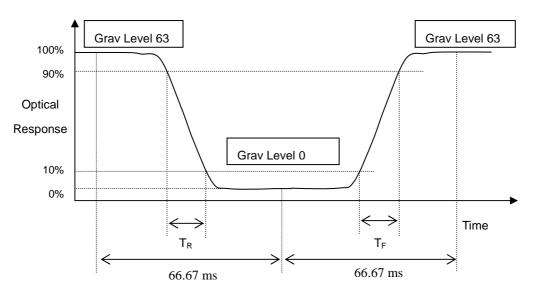
L63: Luminance of gray level 63

L 0: Luminance of gray level 0

CR = CR(1)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

Note (3) Definition of Response Time (T_R, T_F):



Note (4) Definition of Average Luminance of White (LAVE):

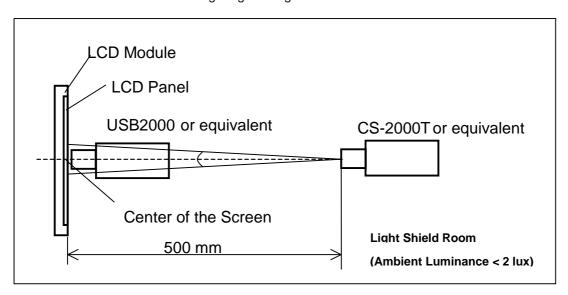
Measure the luminance of gray level 63 at 5 points

$$L_{AVE} = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$$

L(x) is corresponding to the luminance of the point X at Figure in Note (6)

Note (5) Measurement Setup:

The LCD module should be stabilized at given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.

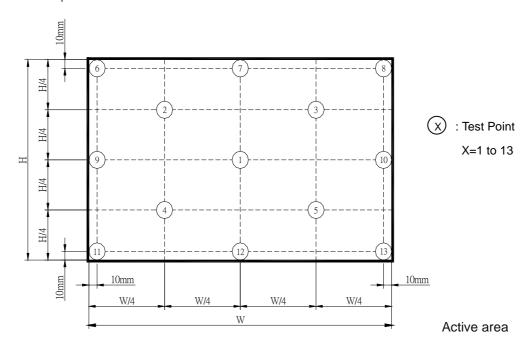


Note (6) Definition of White Variation (δW):

Measure the luminance of gray level 63 at 5 points

$$\delta W_{5p} = Maximum [L(1) \sim L(5)] / Minimum [L(1) \sim L(5)]$$

$$\delta W_{13p}$$
 = Maximum [L(1) \sim L(13)] / Minimum [L(1) \sim L(13)]



Note (7) The listed optical specifications refer to the initial value of manufacture, but the condition of the specifications after long-term operation will not be warranted.

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6. RELIABILITY TEST ITEM

Test Item	Test Condition	Note
High Temperature Storage Test	60°C, 240 hours	
Low Temperature Storage Test	-20°C, 240 hours	
Thermal Shock Storage Test	-20°C, 0.5hour←→60°C, 0.5hour; 100cycles, 1hour/cycle	
High Temperature Operation Test	50°C, 240 hours	(1) (2)
Low Temperature Operation Test	0°C, 240 hours	
High Temperature & High Humidity Operation Test	50°C, RH 80%, 240hours	
ESD Test (Operation)	150pF, 330Ω, 1sec/cycle Condition 1 : Contact Discharge, ±8KV Condition 2 : Air Discharge, ±15KV	(1)
Shock (Non-Operating)	220G, 2ms, half sine wave,1 time for each direction of ±X,±Y,±Z	(1)(3)
Vibration (Non-Operating)	1.5G / 10-500 Hz, Sine wave, 30 min/cycle, 1cycle for each X, Y, Z	(1)(3)

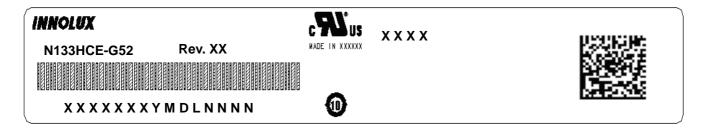
- Note (1) criteria: Normal display image with no obvious non-uniformity and no line defect.
- Note (2) Evaluation should be tested after storage at room temperature for more than two hour
- Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.



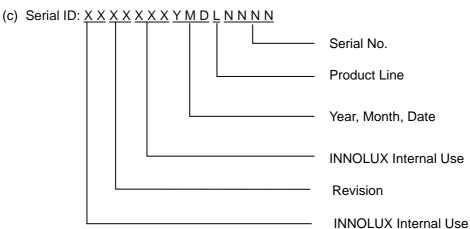
7. PACKING

7.1 MODULE LABEL

The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



- (a) Model Name: N133HCE-G52
- (b) Revision: Rev. XX, for example: C1, C2 ...etc.



Serial ID includes the information as below:

(a) Manufactured Date: Year: 0~9, for 2010~2019

Month: 1~9, A~C, for Jan. ~ Dec.

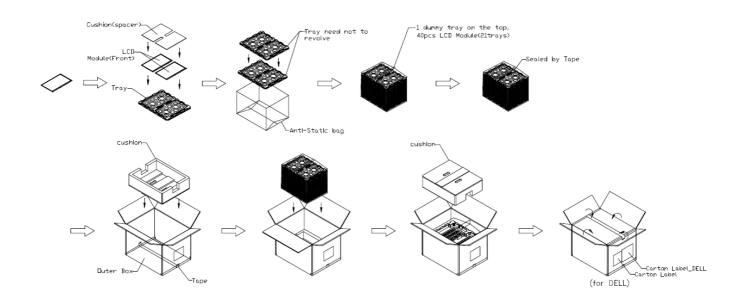
Day: 1~9, A~Y, for 1st to 31st, exclude I, O and U

- (b) Revision Code: cover all the change
- (c) Serial No.: Manufacturing sequence of product
- (d) Product Line: 1 -> Line1, 2 -> Line 2, ...etc.
- (e) UL Logo: XXXX is UL factory ID.



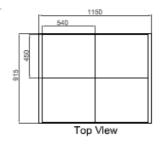
7.2 CARTON

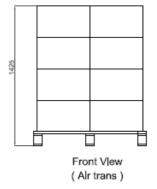
(1)Box Dimensions : 540(L)*450(W)*320(H) (2)40 Modules/Carton

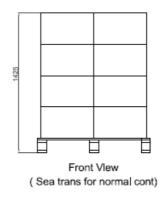


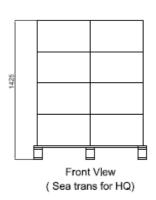


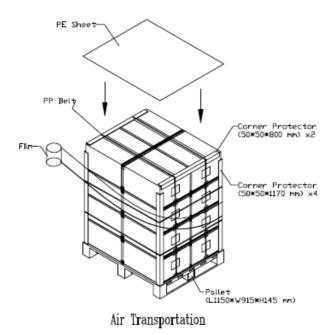
7.3 PALLET

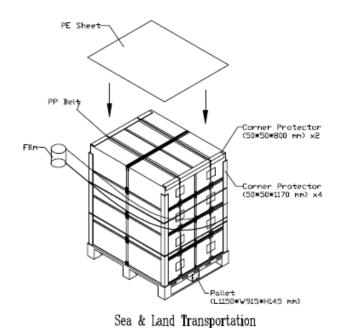






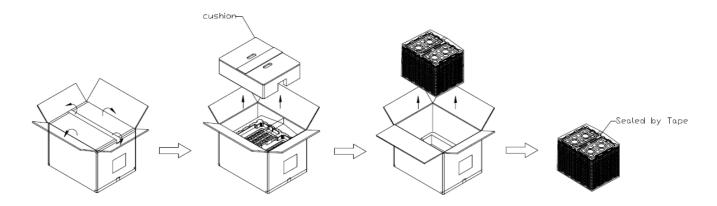


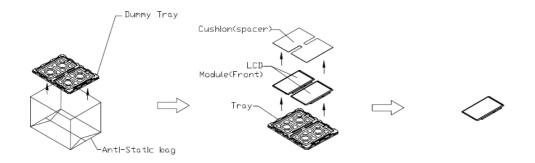






7.4 UN-PACK METHOD







8. PRECAUTIONS

8.1 HANDLING PRECAUTIONS

- (1) The module should be assembled into the system firmly by using every mounting hole. Be careful not to twist or bend the module.
- (2) While assembling or installing modules, it can only be in the clean area. The dust and oil may cause electrical short or damage the polarizer.
- (3) Use fingerstalls or soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (4) Do not press or scratch the surface harder than a HB pencil lead on the panel because the polarizer is very soft and easily scratched.
- (5) If the surface of the polarizer is dirty, please clean it by some absorbent cotton or soft cloth. Do not use Ketone type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanently damage the polarizer due to chemical reaction.
- (6) Wipe off water droplets or oil immediately. Staining and discoloration may occur if they left on panel for a long time.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contacting with hands, legs or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static electricity, it may cause damage to the C-MOS Gate Array IC.
- (9) Do not disassemble the module.
- (10) Do not pull or fold the LED wire.
- (11) Pins of I/F connector should not be touched directly with bare hands.

8.2 STORAGE PRECAUTIONS

- (1) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (2) It is dangerous that moisture come into or contacted the LCD module, because the moisture may damage LCD module when it is operating.
- (3) It may reduce the display quality if the ambient temperature is lower than 10 °C. For example, the response time will become slowly, and the starting voltage of LED will be higher than the room temperature.

8.3 OPERATION PRECAUTIONS

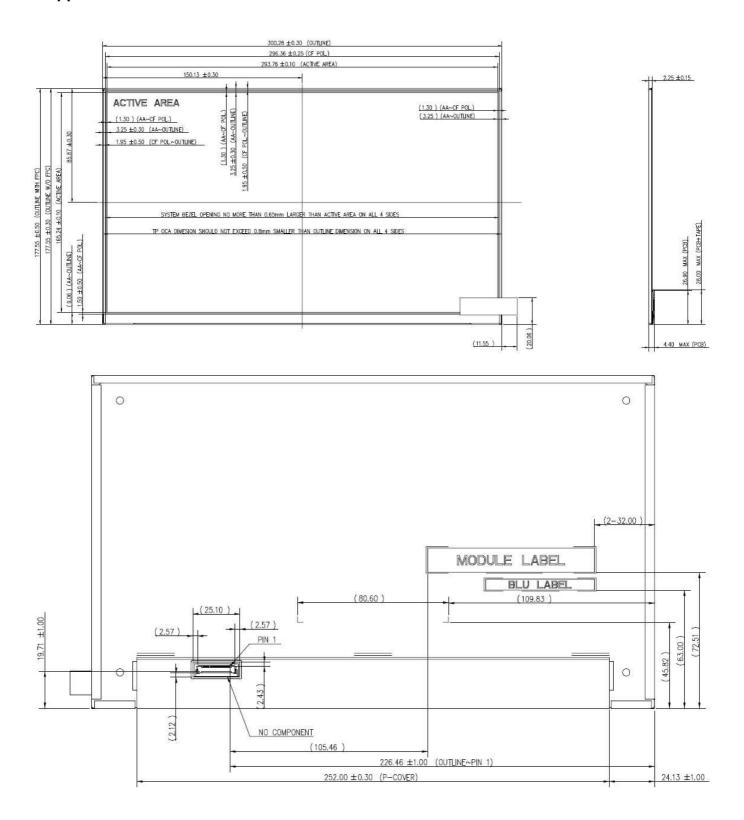
- (1) Do not pull the I/F connector in or out while the module is operating.
- (2) Always follow the correct power on/off sequence when LCD module is connecting and operating. This can prevent the CMIS LSI chips from damage during latch-up.
- (3) The startup voltage of Backlight is approximately 1000 Volts. It may cause electrical shock while assembling with converter. Do not disassemble the module or insert anything into the Backlight unit.



Appendix. EDID DATA STRUCTURE

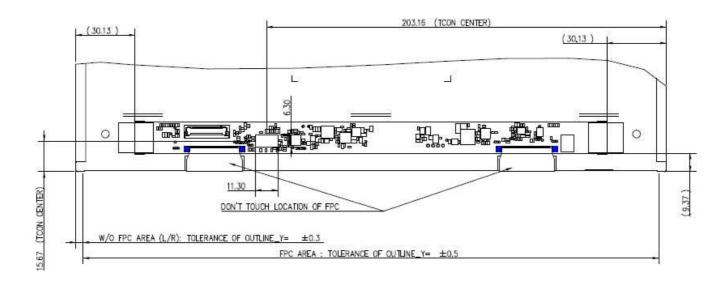
The EDID (Extended Display Identification Data) data formats are to support displays as defined in the VESA Plug & Display and FPDI standards.

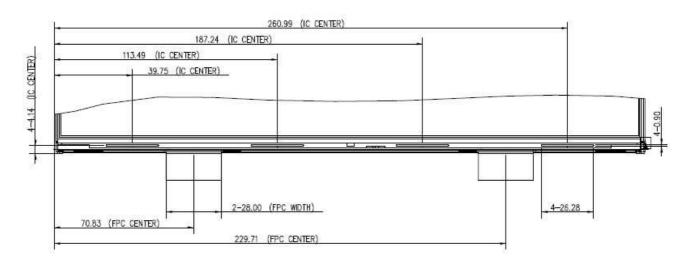
Appendix. OUTLINE DRAWING



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- NOTES:

 1. IN ORDER TO AVOID ABNORMAL DISPLAY, POOLING AND WHITE SPOT,
 NO OVERLAPPING IS SUGGESTED AT CABLES, ANTENNAS, CAMERA, WLAN, WAN OR
 FOREIGN OBJECTS OVER FPC, AND T-CON LOCATIONS.

 2. EDP CONNECTOR IS MEASURED AT PINI AND ITS MATING LINE.

 3. MODULE FLATNESS SPEC (0.5 mm) MAX.(SPEC WILL BE MODIFIED AFTER DVT CHECK).

 4. "()" MARKS THE REFERENCE DIMENSION.



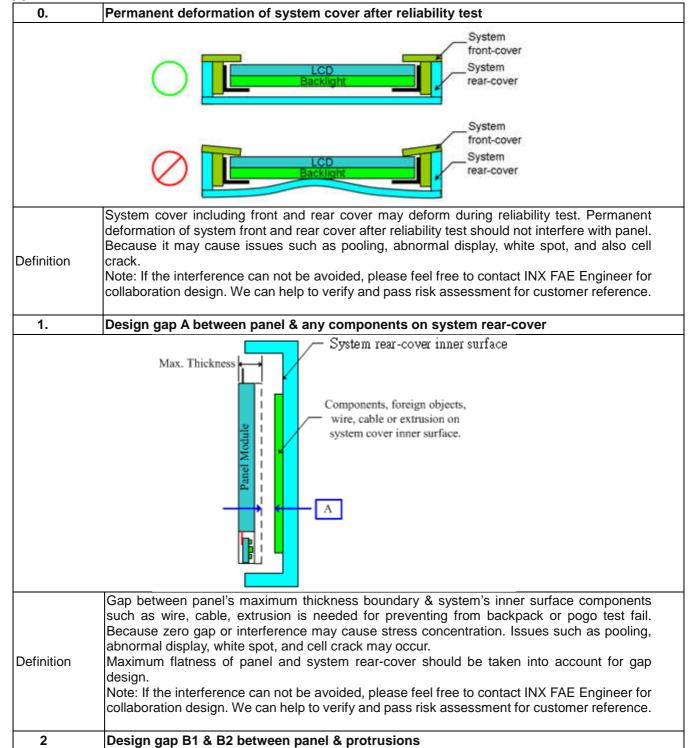
Note. Dimensions measuring instruments as below,

1. Length/ Width/Thickness : Caliper

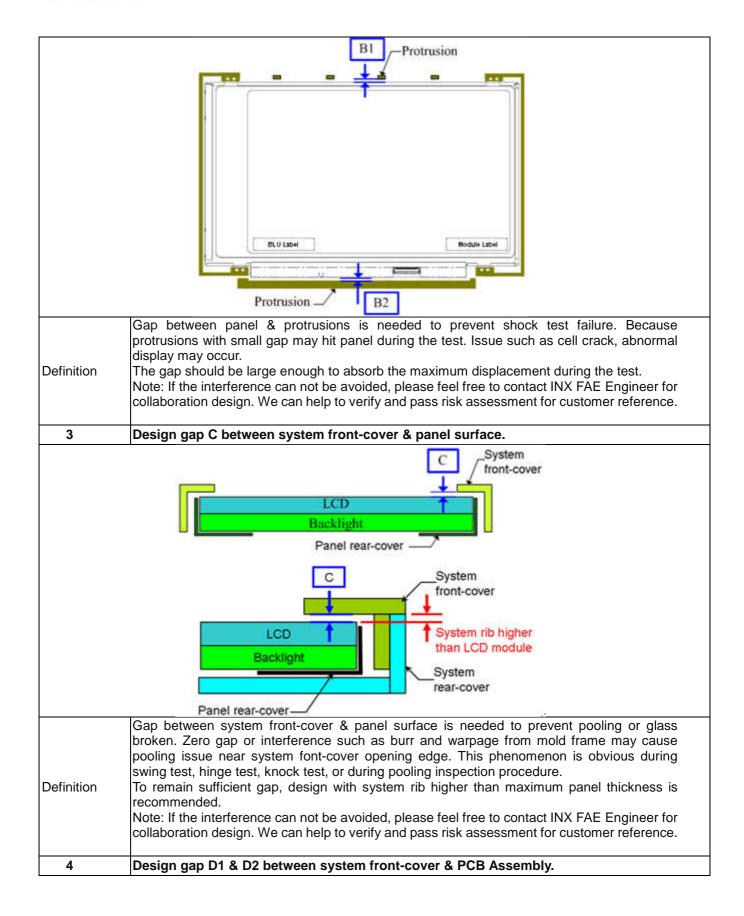
2. Height : Height gauge

Appendix. SYSTEM COVER DESIGN GUIDANCE

Ver.7

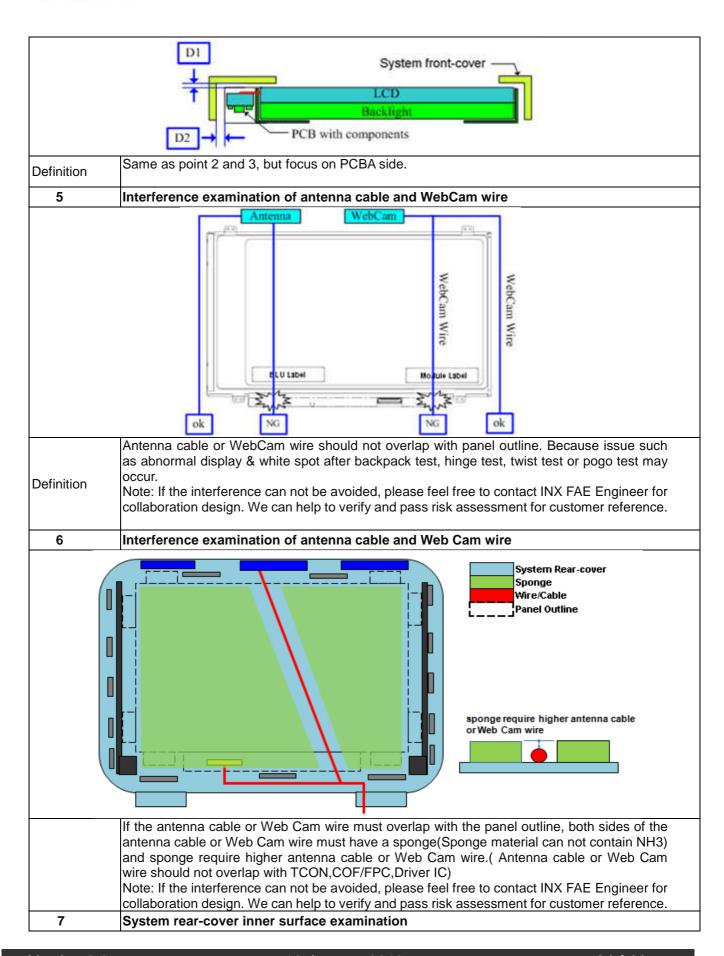






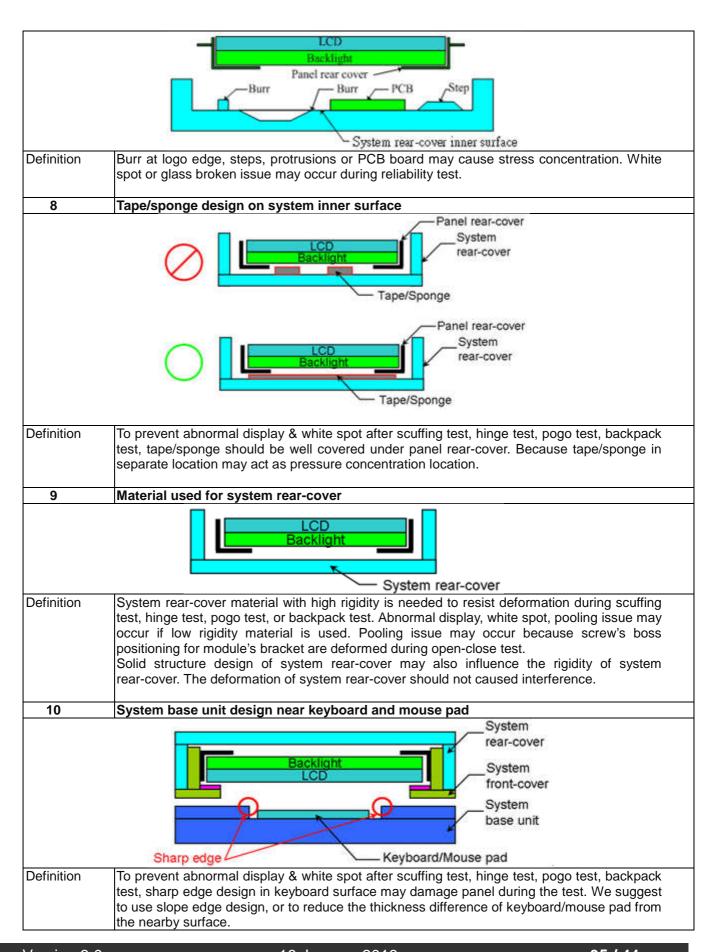
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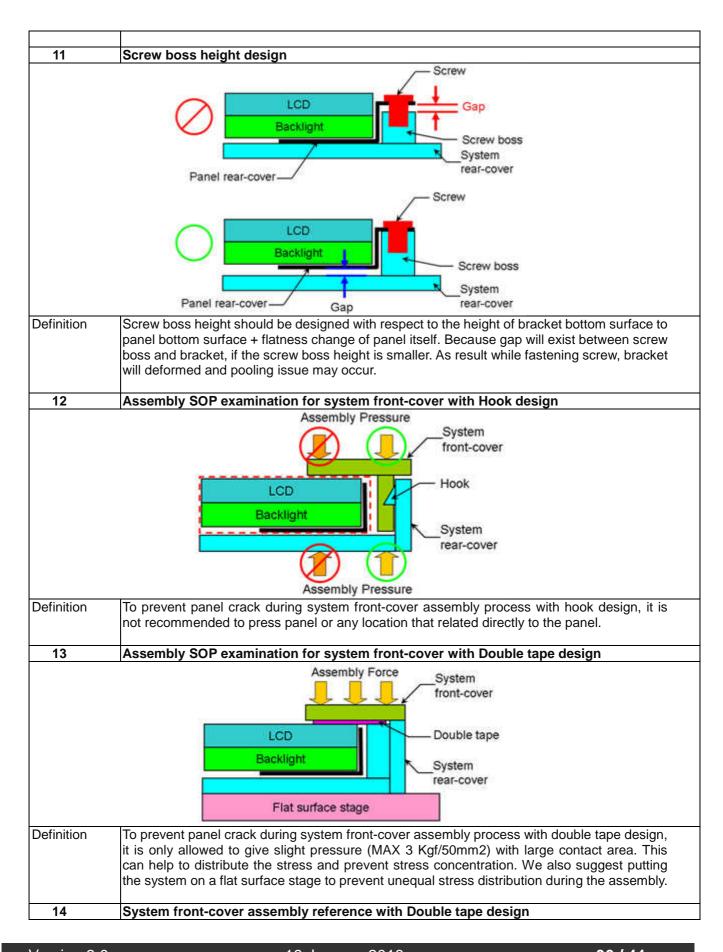
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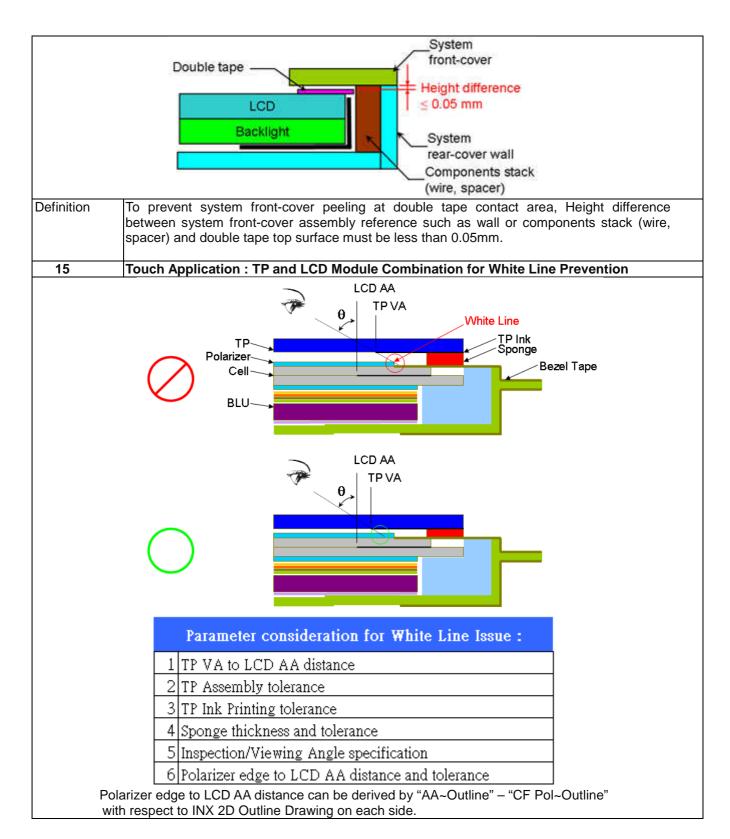
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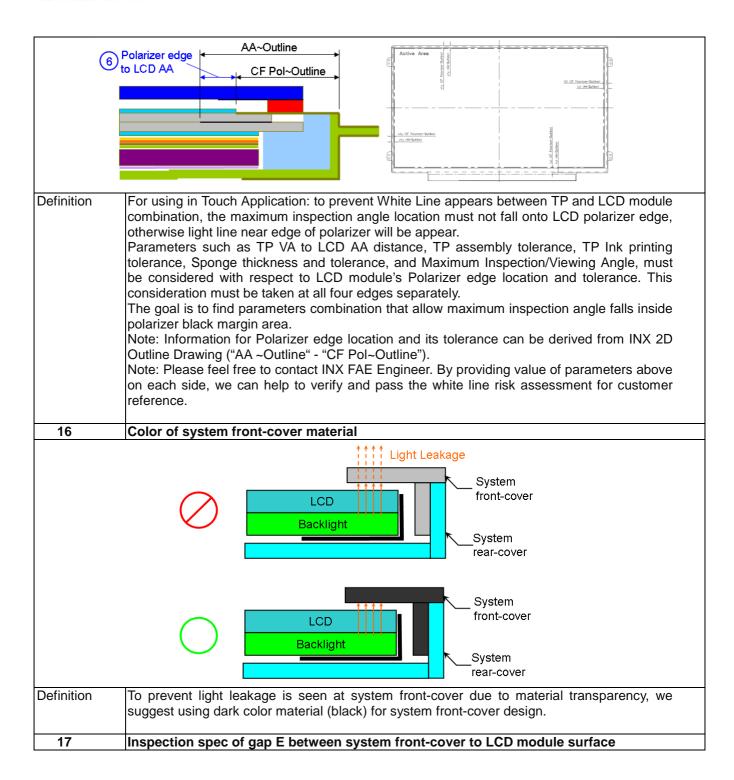
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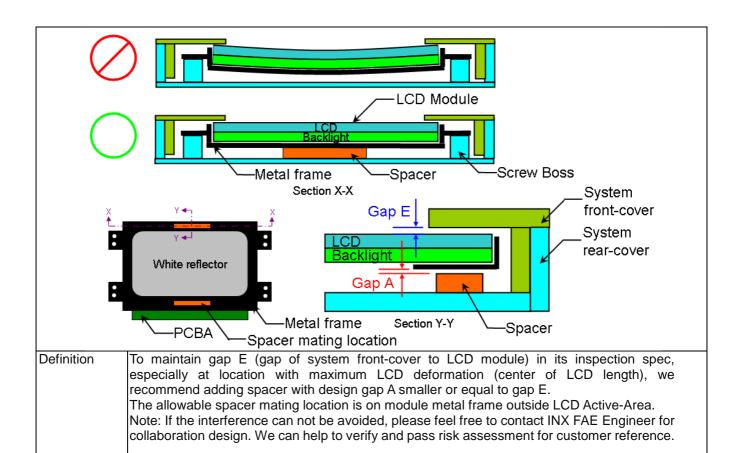


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Appendix. LCD MODULE HANDLING MANUAL

Appendix. LCD MODULE HANDLING MANUAL			
Purpose	 This SOP is prepared to prevent panel dysfunction possibility through incorrect handling procedure. This manual provides guide in unpacking and handling steps. Any person which may contact / related with panel, should follow guide stated in this manual to prevent panel loss. 		
1.	Unpacking		
		Open carton	Remove EPE Cushion
Open	plastic bag	Cut Adhesive Tape	Remove EPE Cushion
2.	Panel Lifting		



Remove PET Cover







Handle with care (see next page)





Finger Slot

Use slots at both sides for finger insertion. Handle panel upward with care.

3. Do and Don't

Do:

- Handle with both hands.
- Handle panel at left and right edge.



Don't:

Lifting with one hand.



Handle at PCBA side.





Don't:

Stack panels.



Press panel.



Don't:

- Put foreign stuff onto panel



- Put foreign stuff under panel



Don't:

 Paste any material unto white reflector sheet



Don't:

 Pull / Push white reflector sheet





Don't:

· Hold at panel corner.



Don't:

Twist panel.



Do:

 Hold panel at top edge while inserting connector.



Don't:

 Press white reflector sheet while inserting connector.





Do:

 Remove panel protector film starts from pull tape



Don't:

 Remove panel protector film From film another side.



Don't:

Touch or Press PCBA Area.



